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Intel® Server Chassis H2216XXKR

| Specifications | ^ |
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| - Essentials | |
|--|--|
| Launch Date | Q3'12 |
| Status | End of Life |
| Expected Discontinuance | Q4'15 |
| EOL Announce | Thursday, October 15, 2015 |
| Last Order | Friday, April 15, 2016 |
| Last Receipt Attributes | Friday, July 15, 2016 |
| Limited 3-year Warranty | Yes |
| Extended Warranty Available for Purchase (Select Countries) | Yes |
| Chassis Form Factor | 2U Rack |
| Chassis Dimensions | 17.2" x 30.5" x 3.5" |
| Description | A 2U rack chassis supporting up to four hot-pluggable compute modules (S2600JF, S2600WP, o S2600LP Families) up to 16 2.5" hot-swap HDDs, two 1600W common redundant power supplies for HPC environments. |
| Target Market | High Performance Computing |
| Power Supply | 1600 W |
| Power Supply Type | AC |
| # of Power Supply Included | 2 |
| Redundant Fans | No |
| Redundant Power Supported | Yes |
| Backplanes | Included |
| Included Items | (1) Intel® Server Chassis H2216XXKR (17.2" x 30.5" x 3.5"), (1) 2.5" 6Gb/s SATA/SAS Backplane; (16) 2.5" Hot-swap drive carriers, (2) 1600W Common redundant power supply (Platinum Efficiency), (2) Power distribution board, (4) Node fillers, and (1) Value rail kit. |
| # of Front Drives Supported | 16 |
| Front Drive Form Factor | Hot-swap 2.5" |
| Additional Information URL | Link |
| Recommended Customer Price | N/A |

Related Products 2U Rack Server Chassis Intel® Server Chassis H2000 Family

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PCN/MDDS Information

919023: PCN | MDDS

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Refer to Datasheet for formal definitions of product properties and features

"Announced" SKUs are not yet available. Please refer to the Launch Date for market availability.

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